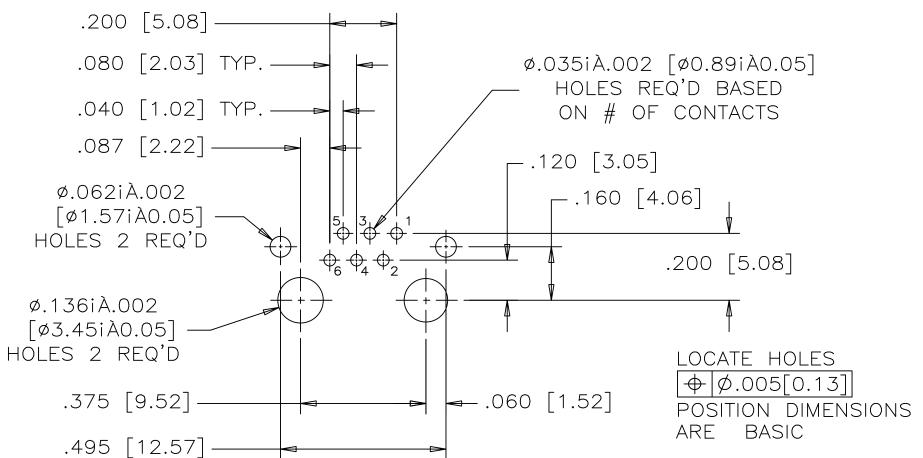
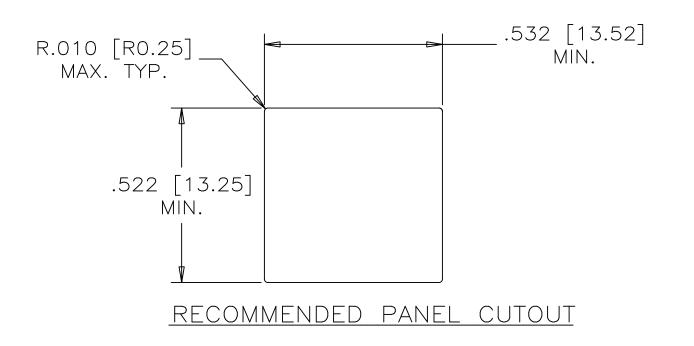


SIDE VIEW



## RECOMMENDED P.C.B. LAYOUT

(COMPONENT SIDE OF BOARD) (RJE01-662-01 SHOWN, FOOTPRINT FOROTHER PART NUMBERS BASED ON # OF CONTACTS & RELATED POSITIONS)



1. MATERIALS:

HIGH TEMPERATURE ENGINEERING THERMOPLASTIC HOUSING:

FLAMMABILITY RATING UL 94V-0, BLACK

PHOSPHOR BRONZE CONTACTS:

PLATING: 50  $\mu$ " [1.27 MICRONS]

MIN. GOLD ON MATING SURFACES.

50  $\mu$ " [1.27 MICRONS] MIN. NICKEL UNDERPLATE 100  $\mu$ " [2.54 MICRONS]

MIN. MATTE TIN ON CONTACT TAILS.

SHIELD: COPPER ALLOY

PLATING: NICKEL WITH TIN DIPPED PCB TAILS.

2. ENVIRONMENTAL:

OPERATING TEMPERATURE: -55°C to 85 °C

3. RECOMMENDED SOLDERING TEMPERATURE:

WAVE SOLDERING OR REFLOW SOLDERING AT 260°C

MAXIMUM FOR 5 SEC MAXIMUM.



**CONTACTS:** 

2 = 2 CONTACTS LOADED IN POSITION 3 & 4. 4 = 4 CONTACTS LOADED IN POSITION 2 TO 5.

6 = 6 CONTACTS LOADED IN POSITION 1 TO 6.

DRAWN	L.CHAN	DATE OCT.25/04	Δ
DESIGNED			
CHECKED	K.LAMBIE	OCT.25/04	TITLE
I. E. APPRD.			
Q. A. APPRD.			_
DWG. APPRD.			3
ENG. REL. NO.			DWG
			1

## Imphenol Canada Corp

HIGH SPEED MODULAR JACK, SINGLE PORT, EMI QUIET, 6 POSITION, SHIELDED WITH SIDE TABS- ROHS COMPLIANT

DRAWING NO.

P-RJE01-6X2-01 REF. EAR: RJ13076 DIMENSIONS ARE IN CODE ID. NO. |INCHES [mm]| 03554 |scale  $|_{\mathrm{WT.}}$   $-----|_{\mathrm{SURF.}}$   $-----|_{\mathrm{SHEET}}$  1 of 1

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**Authorized Distributor** 

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Amphenol: RJE01-662-01